

Power Supply Design Seminar

Power Factor Correction (PFC) Circuit Basics

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Power Factor Correction (PFC) Circuit Basics

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Objectives & agenda

- **Introduction**

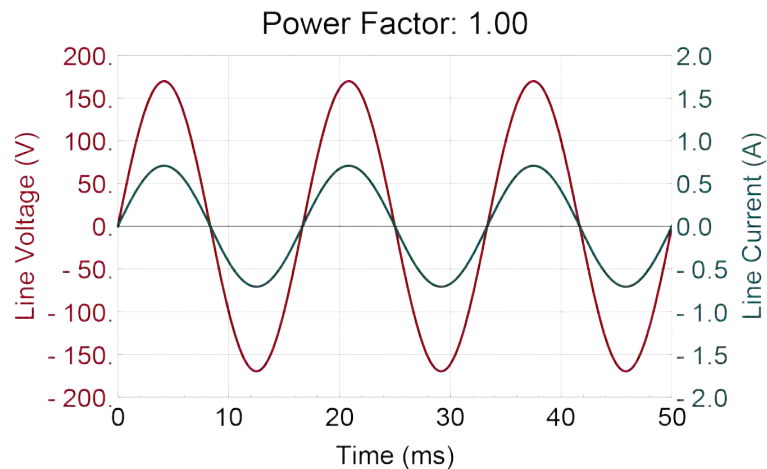
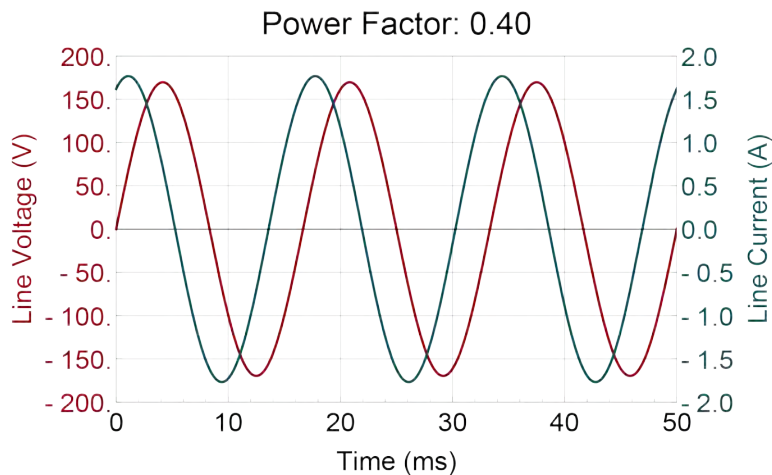
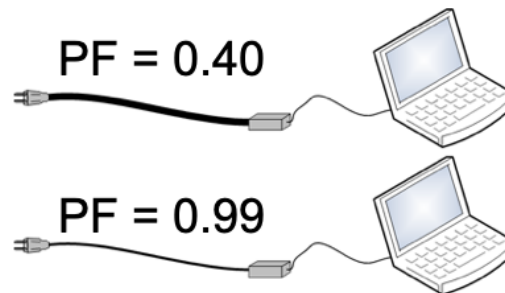
- What is power factor correction (PFC)?
- Why is it needed?
- How is it measured?

- **Overview**

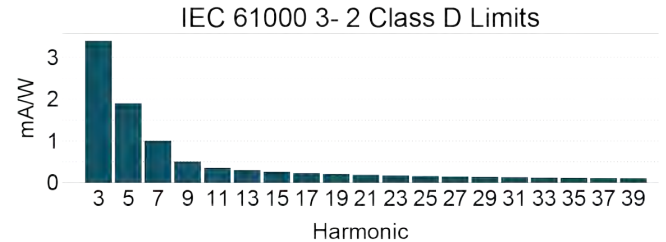
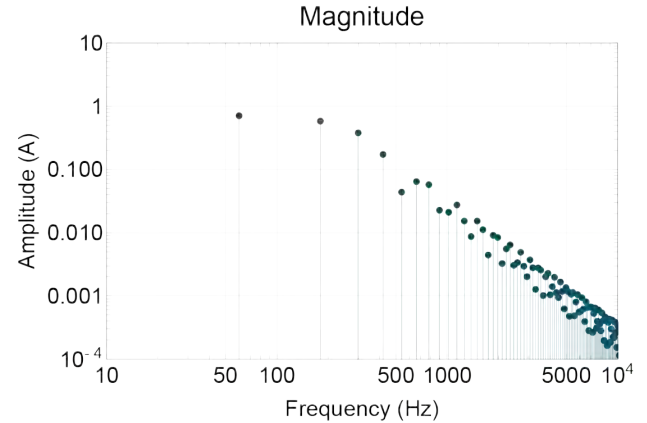
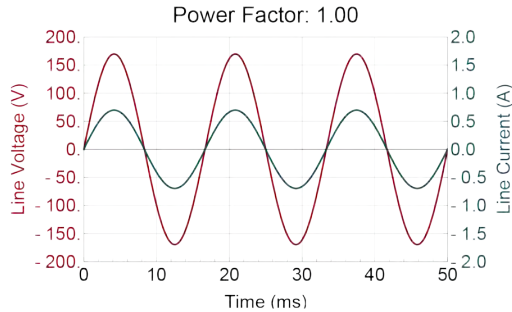
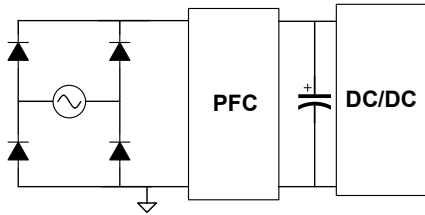
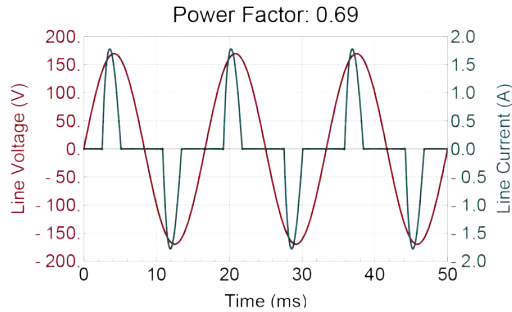
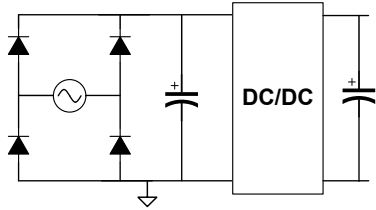
- Critical conduction mode (CrCM)
 - Compensation
 - Feed-forward
 - Sources of distortion
- Continuous conduction mode (CCM)
- Interleaved
- Bridgeless

What is power factor and why should I care?

- Laptop ~ 60 W
- USA > 3.2 TW



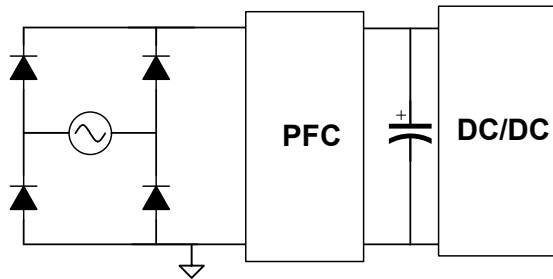
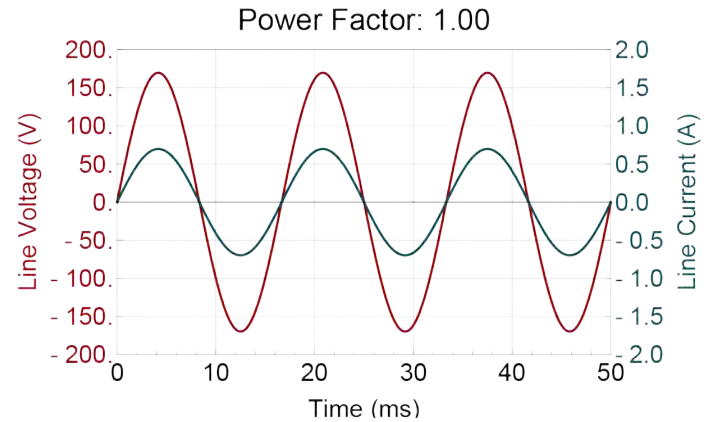
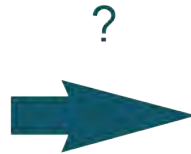
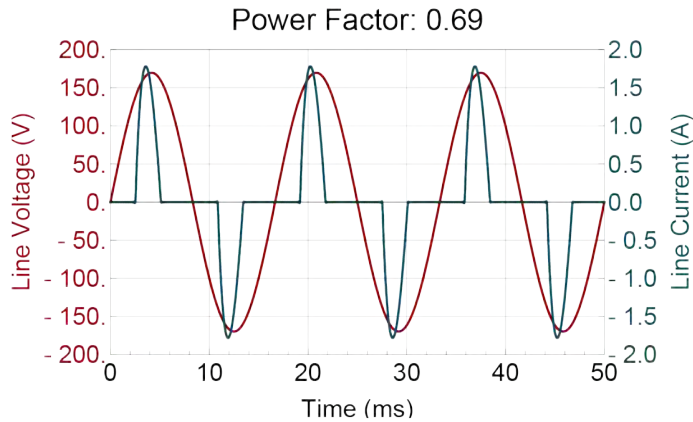
How is the “PF” measured & regulated?



$$THD = \frac{\sqrt{\sum_{n=2}^{\infty} I_n^2}}{I_1}$$

$$PF = \frac{\cos(\varphi)}{\sqrt{1 + THD^2}}$$

How is it done?



Solutions include

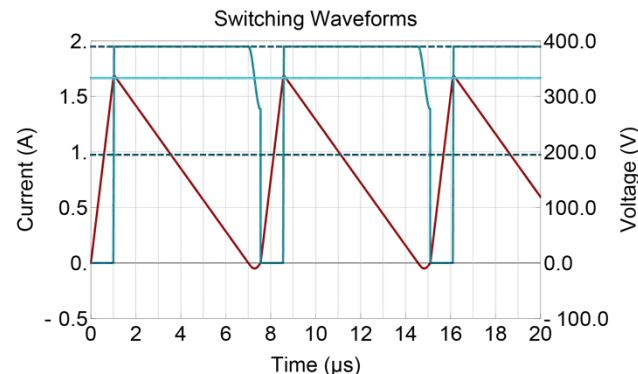
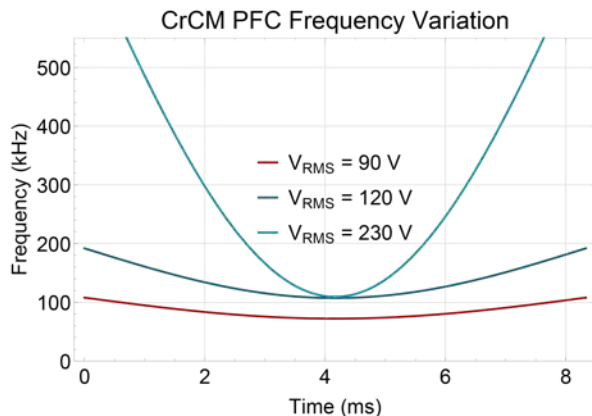
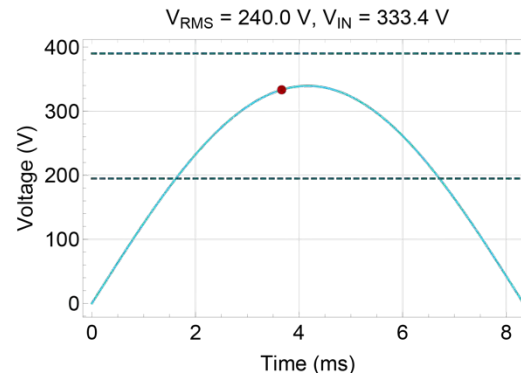
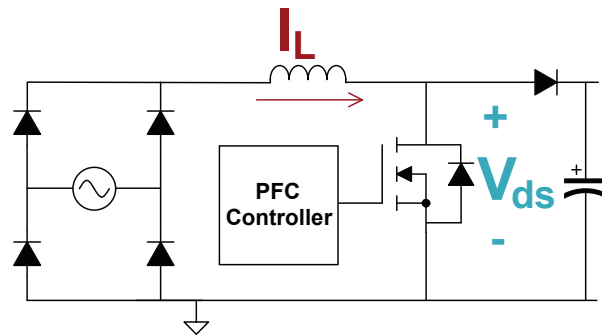
- Boost
- Flyback
- Sepic
- Buck
- Passive solutions

Benefits

- Achieve unity PF
- Regulated output
- Energy hold up
- Universal input

The CrCM PFC

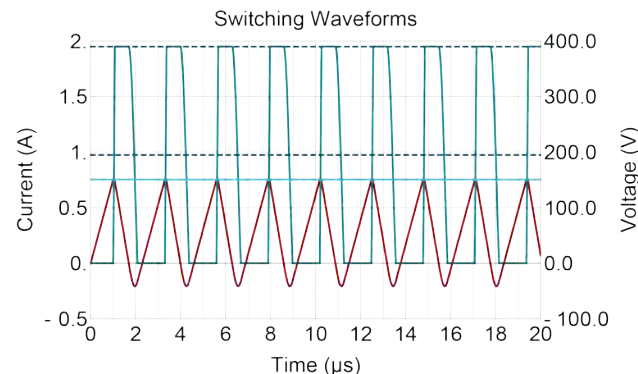
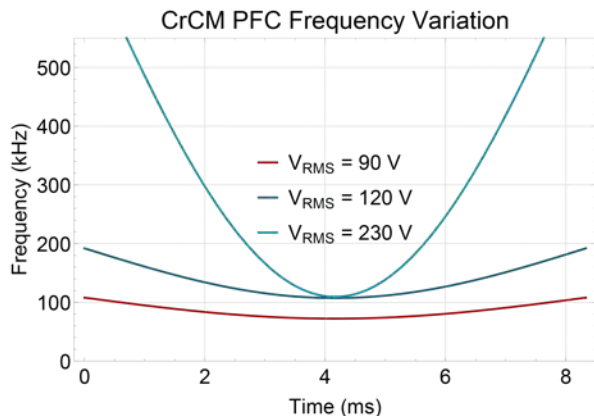
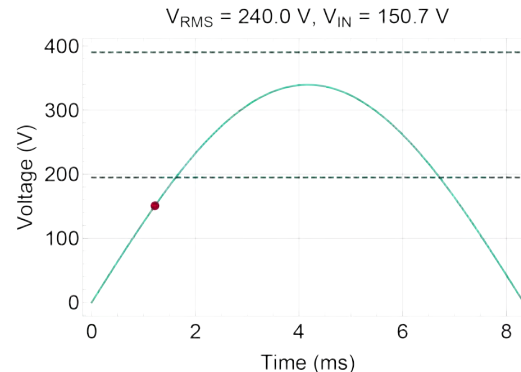
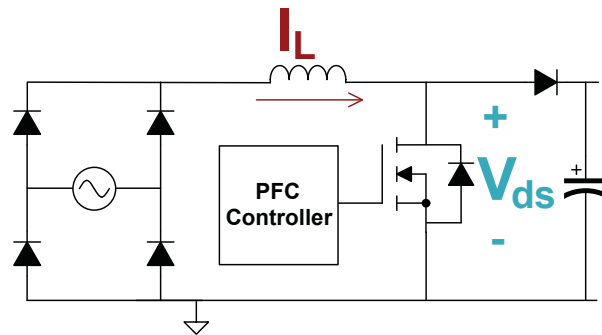
- Constant ON-time
 - $I_{L(AVG)} = \frac{V_{IN}}{2L} t_{ON}$
- Operates on the boundary between DCM and CCM
- Huge switching frequency variation
- Zero current switching for boost diode, no reverse recovery



Note: Time base in zoomed plots is relative to: 3.7 ms.

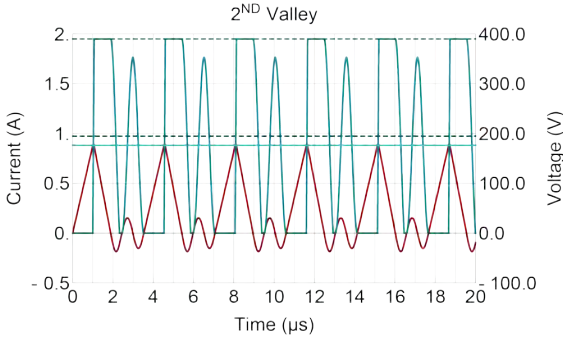
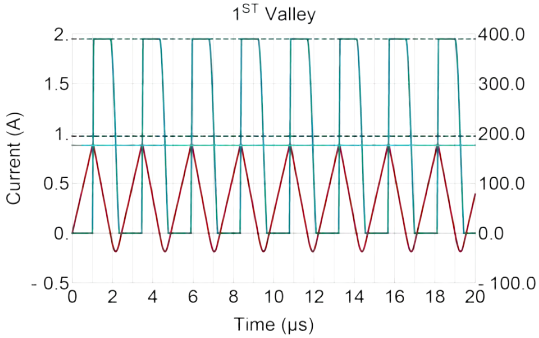
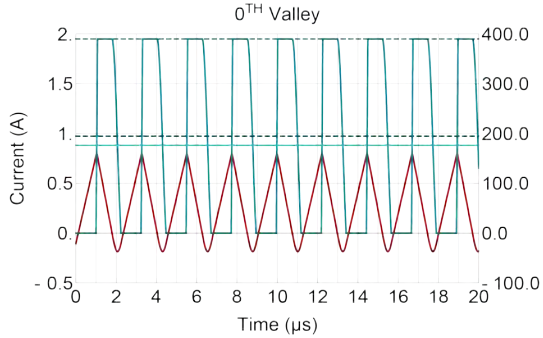
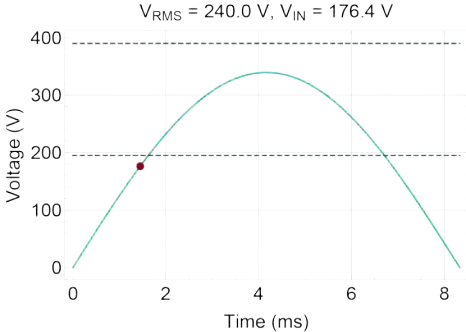
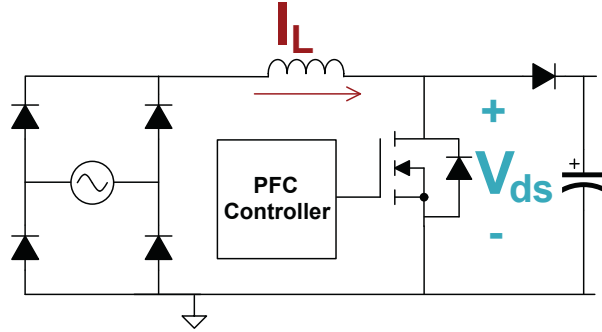
The CrCM PFC

- Constant ON-time
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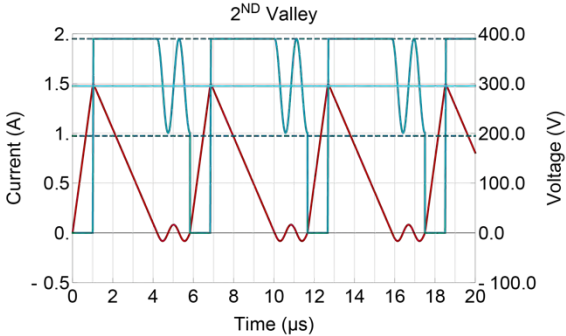
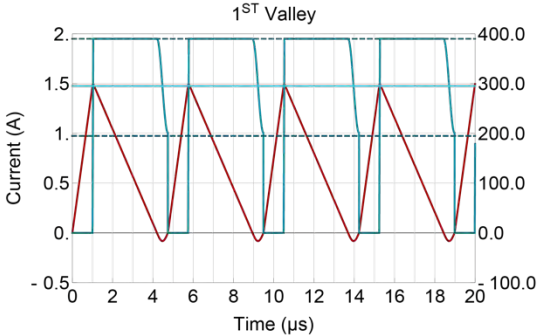
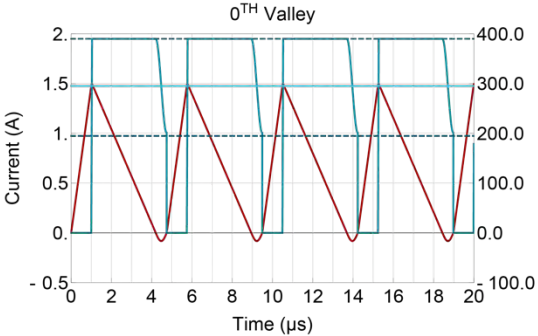
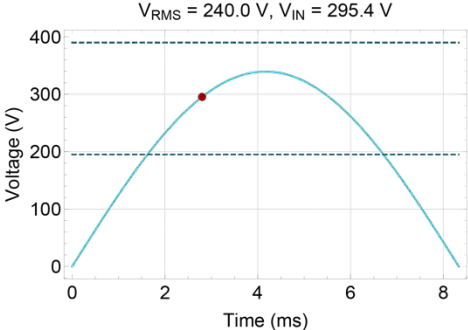
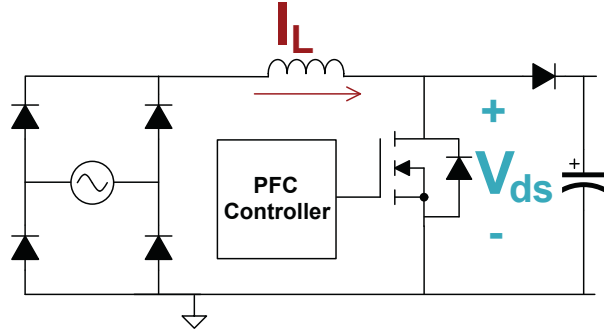


Note: Time base in zoomed plots is relative to: 12 ms.

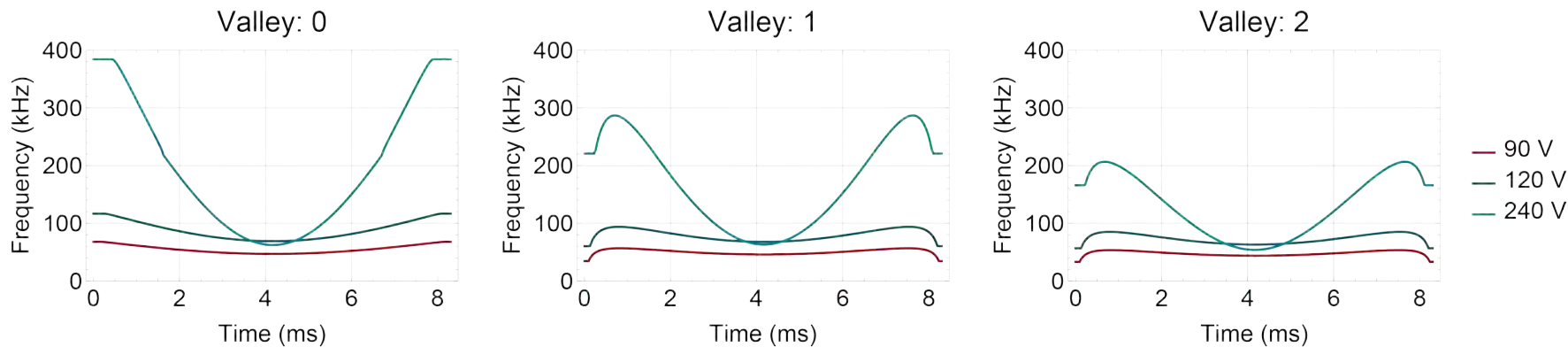
DCM & valley switching



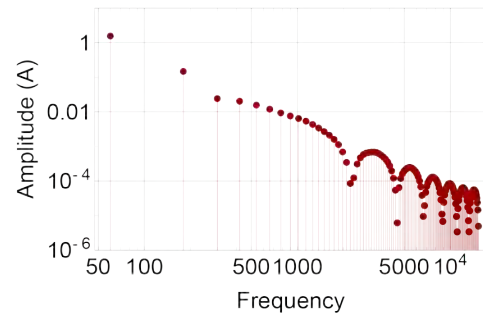
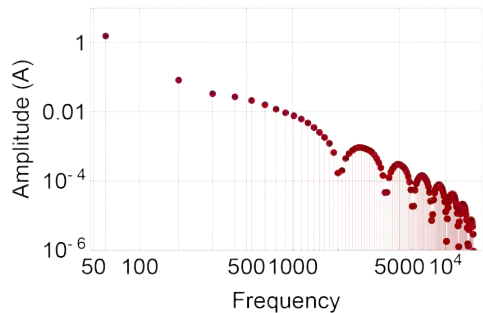
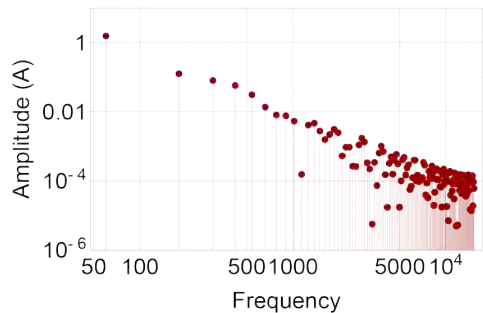
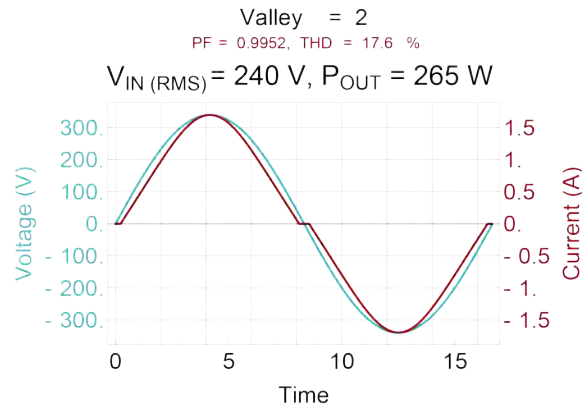
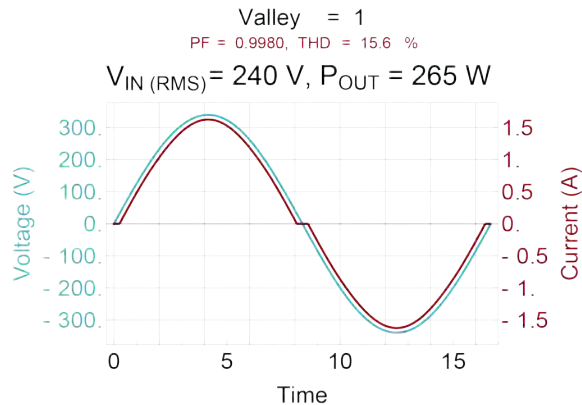
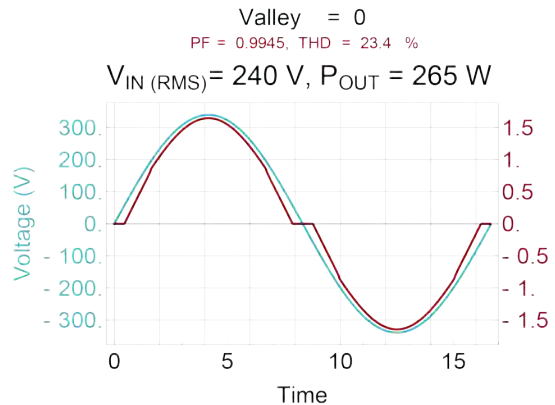
DCM & valley switching



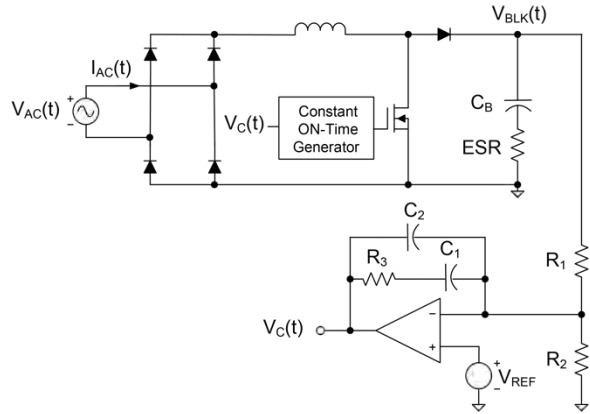
Valley switching impact on f_s



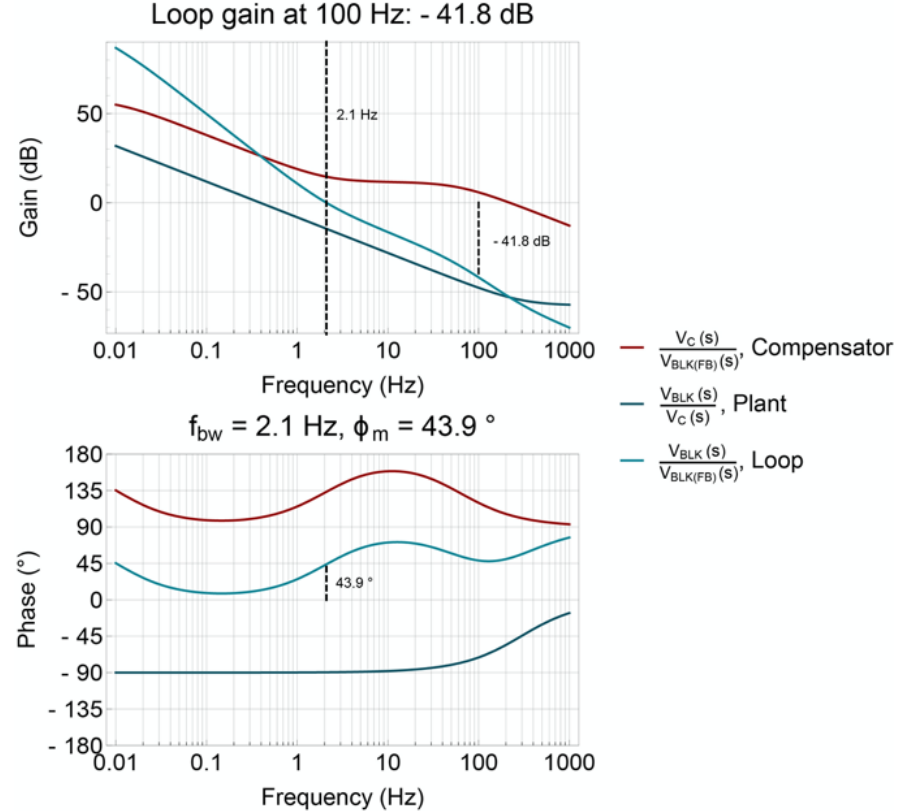
Distortion



Compensation



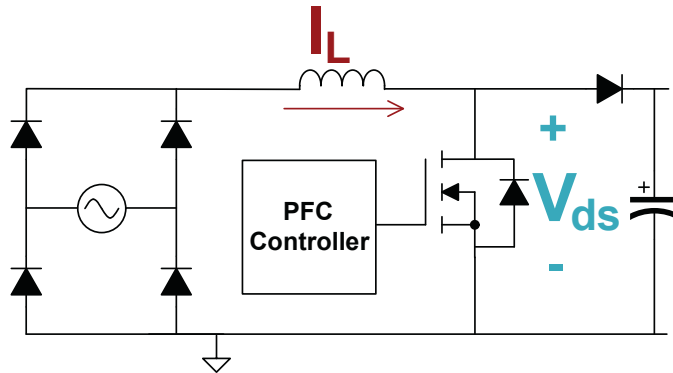
- Feed-forward power delivery independent of line voltage
 - One compensation parameter set works for very wide input voltage range
- Trade-off
 - Good PF requires a slow control loop (<10 Hz typical)
 - Good transient response requires fast control loop
 - Non-linear error amplifier gain helps address transient response performance



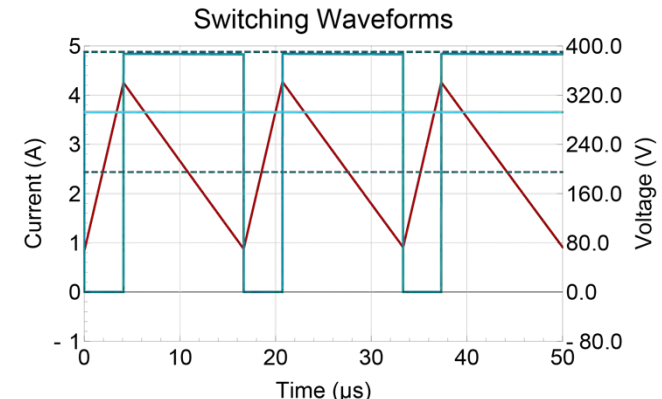
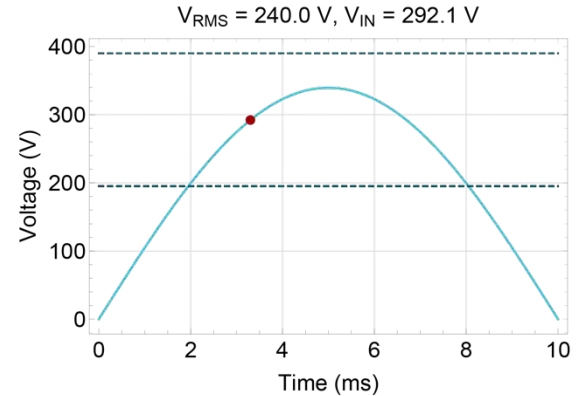
CrCM wrap up – Low solution \$, <300 W

- **Simple implementation**
- **Valley switched**
 - Low C_{OSS} loss at MOSFET turn-on
- **No reverse recovery**
 - Able to use lower cost ultra-fast diode
- **Inductor current ripple is large (200%)**
 - Larger RMS currents
 - Larger core loss in inductor
- **Good PF, mediocre THD**
 - THD can be improved using more complex approaches

CCM PFC operation

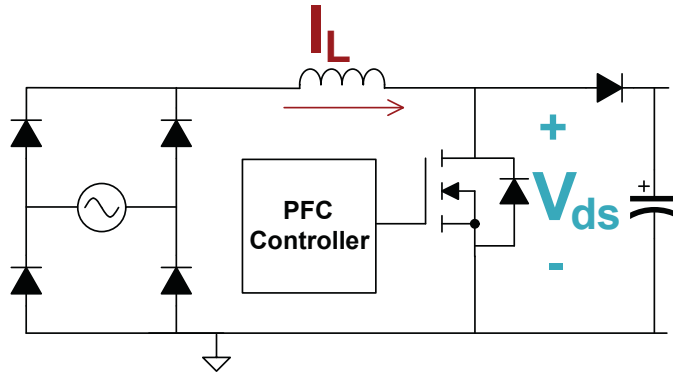


- Converter operates at a fixed switching frequency, duty-cycle now a function of instantaneous line voltage
- Much smaller current ripple than CrCM but no longer valley switched
- Non-ZCS switching for boost diode, good Q_{RR} performance needed
- Capable of delivering a lot more power

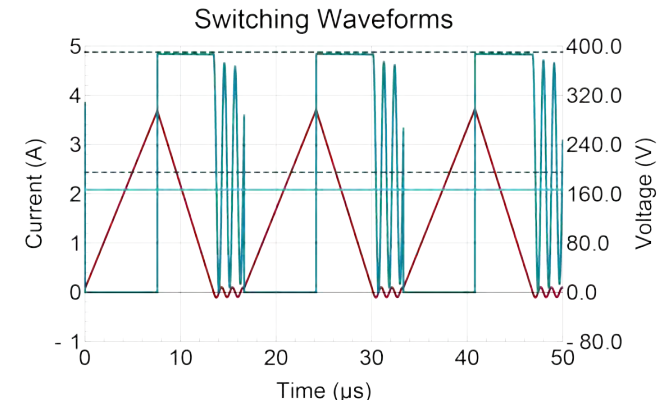
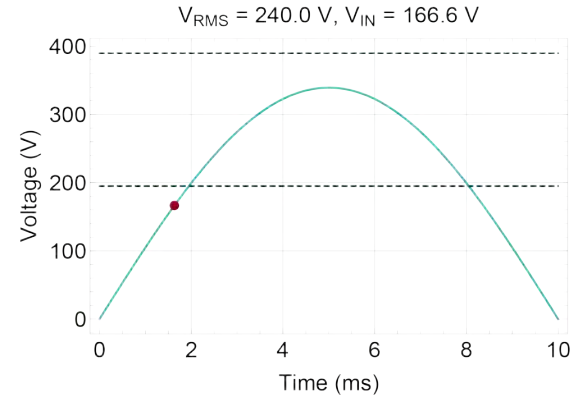


Note: Time base in zoomed plots is relative to: 3.3 ms.

CCM PFC operation

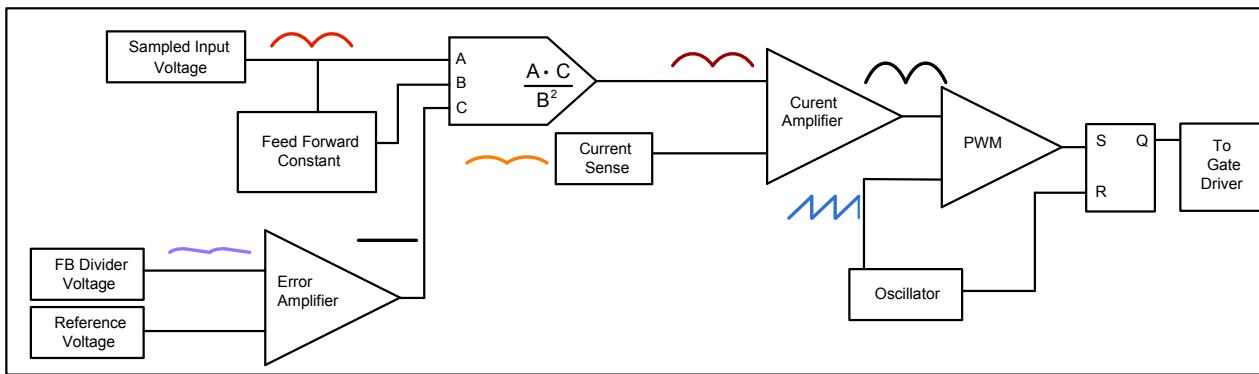
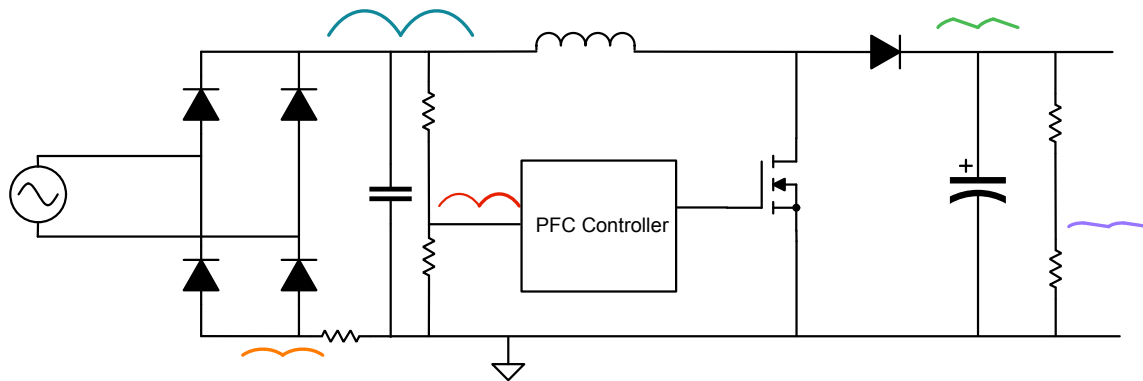


- Converter operates at a fixed switching frequency, duty-cycle now a function of instantaneous line voltage
- Much smaller current ripple than CrCM but no longer valley switched
- Non-ZCS switching for boost diode, good Q_{RR} performance needed
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Note: Time base in zoomed plots is relative to: 1.6 ms.

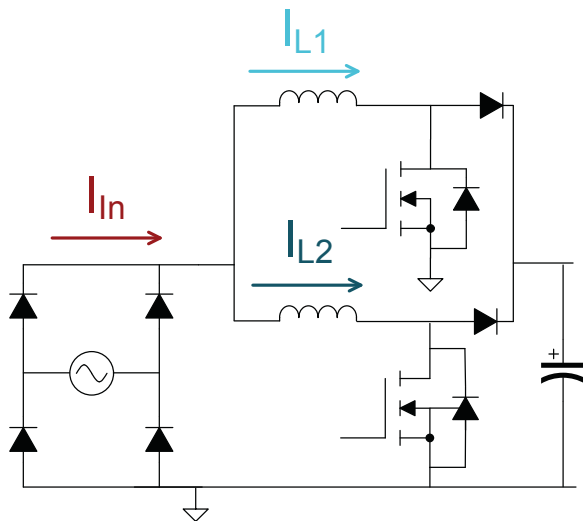
The CCM PFC



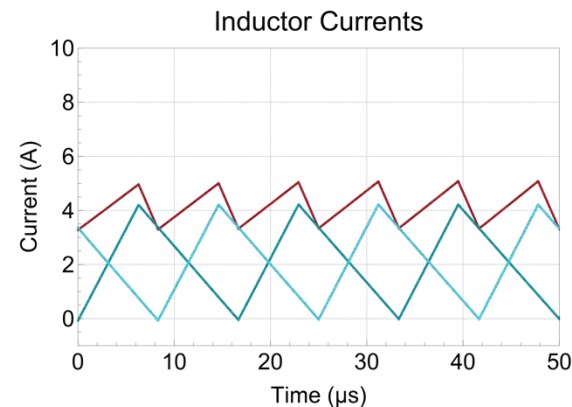
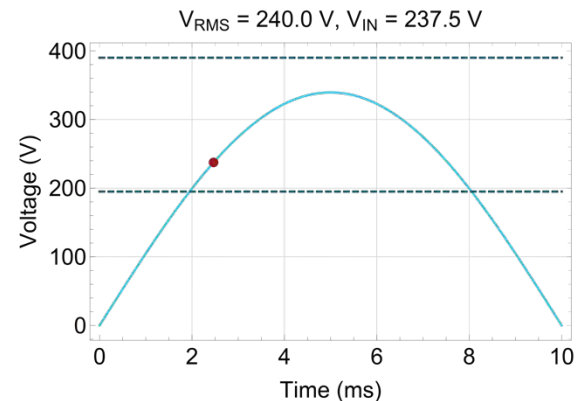
CCM wrap up – Better PF/THD, >300 W

- **Fixed frequency with limited inductor current ripple**
 - Smaller RMS currents
 - Smaller conduction losses than CrCM
 - Lower cost core material
- **Hard switching for both boost MOSFET and boost diode**
 - Higher switching losses than CrCM
 - Good Q_{RR} performance is essential
 - SiC diode often used
- **More complex control scheme**
 - Slow voltage loop, fast current loop
 - Most modern CCM PFC controllers will simplify complexity for the end user

Interleaved PFC

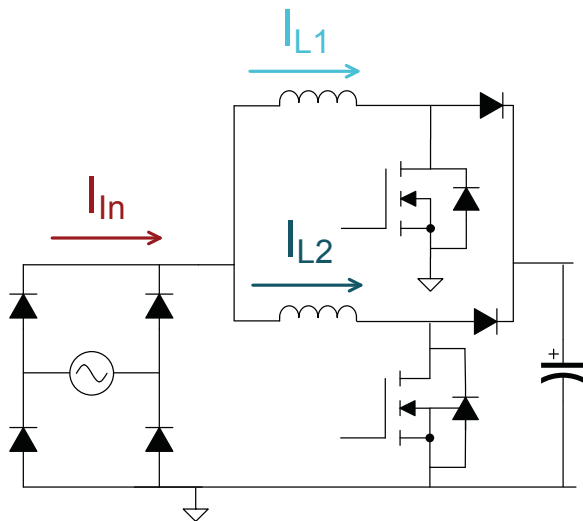


- Two converters operated 180° out of phase
- Works with CrCM or CCM types
- Ripple cancellation at 50% duty-cycle

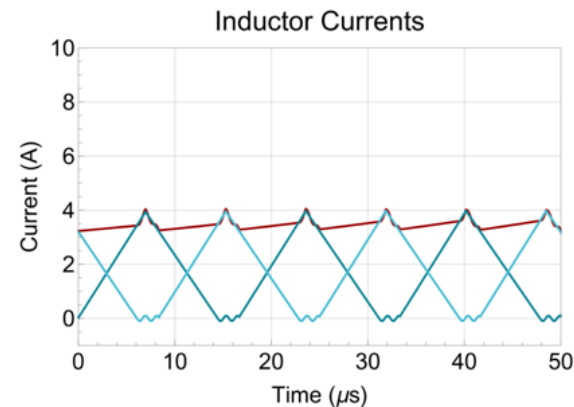
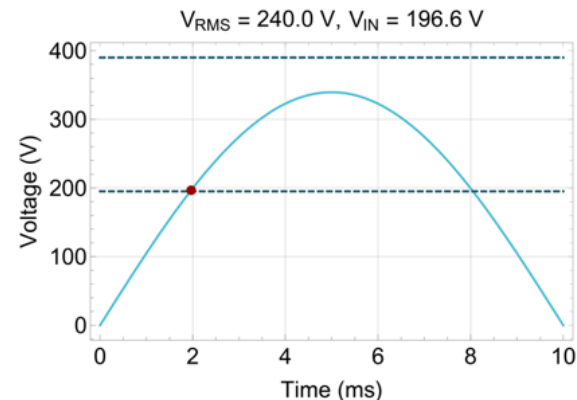


Note: Time base in zoomed plots is relative to: 2.5 ms.

Interleaved PFC



- Two converters operated 180° out of phase
- Works with CrCM or CCM types
- Ripple cancellation at 50% duty-cycle



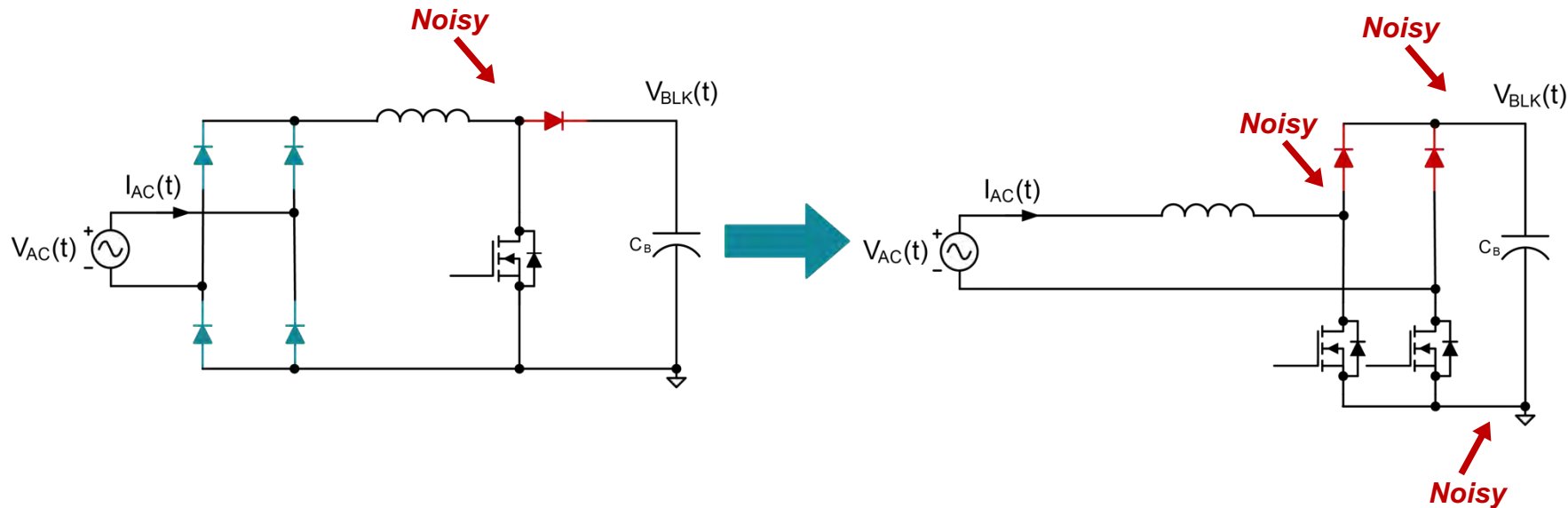
Note: Time base in zoomed plots is relative to: 2.0 ms.

When to consider interleaving

- **Power loss distributed between two power stages**
 - Improved thermal management
 - More component choices
- **Power density**
 - Reduced z-height at the expense of x/y space
- **Lower input and output current ripple**
 - EMI filter may be physically smaller

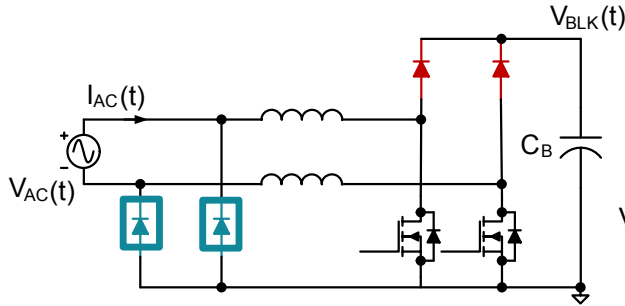
I want bridgeless, can I do this?

Slow
Fast



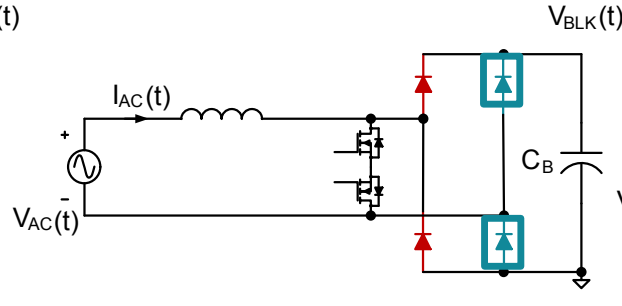
Bridgeless PFC

Slow
Fast



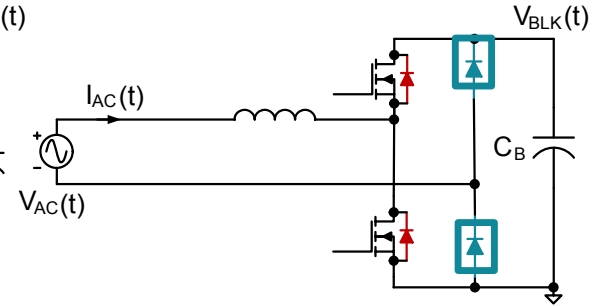
Semi-Bridgeless

- Advantages
 - Simple control
 - Ground referenced gate drive
- Disadvantages
 - 2 power stages
 - 6 semiconductors
 - Poor core utilization



AC Switch

- Advantages
 - Lowest ON-state conduction
 - Balanced EMI
- Disadvantages
 - Isolated drive
 - Current sense
 - 6 semiconductors

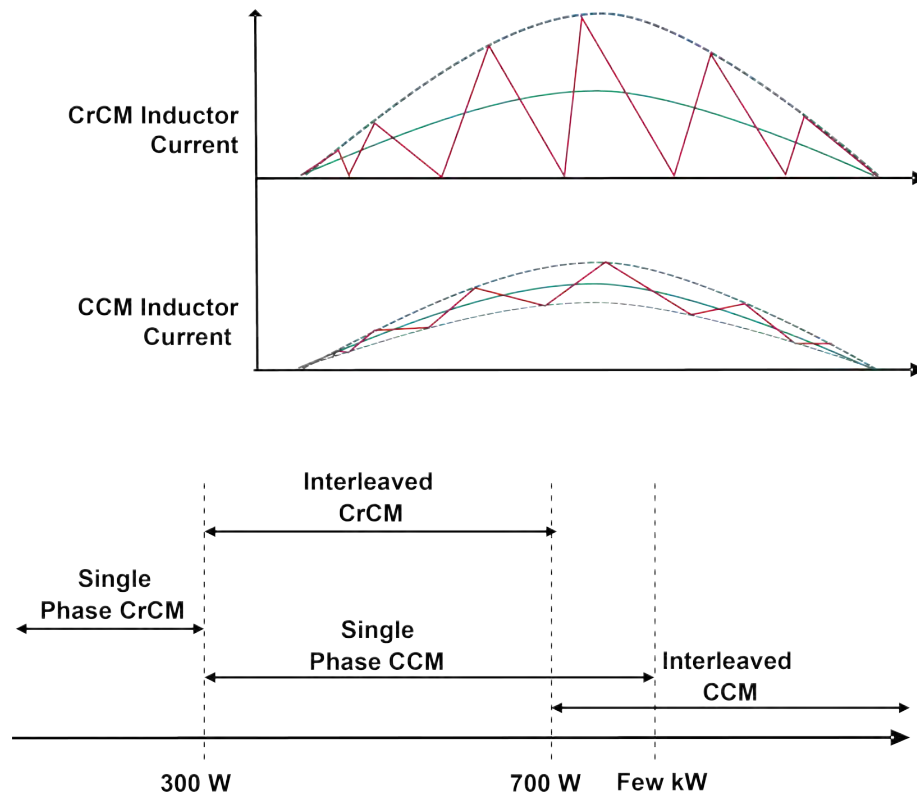


Totem Pole

- Advantages
 - Minimum components
 - Good efficiency
- Disadvantages
 - Complex
 - High side drive
 - Current sense
 - Common mode
 - Reverse recovery

Selecting the right PFC topology: Output power

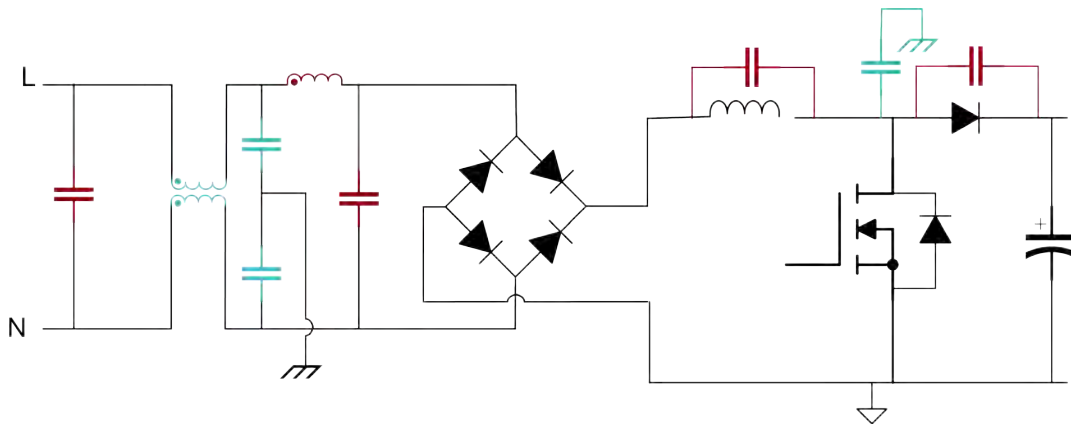
- How does output power influence decision?
- Peak inductor current comparison at 500 W
 - Single phase CCM: 8.84 A
 - Single phase CrCM: 17.49 A



Selecting the right PFC topology: Interleaved CrCM vs single phase CCM

Design Characteristics	Interleaved CrCM	Single Phase CCM
Component stress	Conduction loss split between two power stages, valley switched	Single power stage, hard switched
Power density	Lower	Higher
Height	Smaller overall component height	Single inductor, larger heatsinks
Thermal management	Power dissipation spread over greater X/Y space	More challenging
Complexity	High power stage component count	Single power stage
Cost	Higher	Lower

Selecting the right PFC topology: EMI comparison



- **Critical conduction mode**

- Inductor current ripple is 200%, requires physically larger EMI filter
- Variable frequency – noise less concentrated in one frequency

- **Continuous conduction mode**

- Physically smaller filter but fixed frequency

- **Interleaved**

- Ripple current cancellation allows for physically smaller EMI filter

- **Bridgeless**

- Common mode challenging for some variations

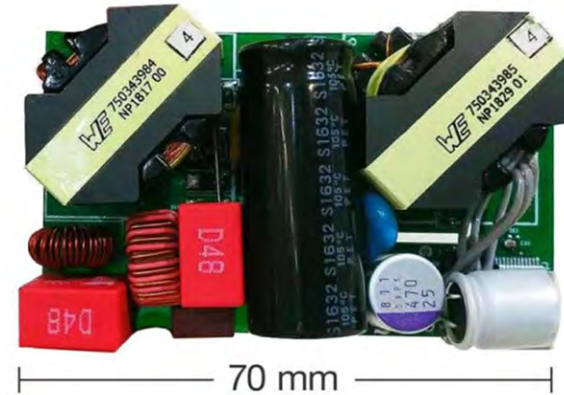
Topology selection exercise

Design specification

- Laptop adaptor
- USB-C, 100 W output
- 100 V_{AC} to 240 V_{AC} input
- Smallest form factor critical

TIDA-01623

- Single phase CrCM PFC + active clamp flyback
- Form factor: 70 mm × 42 mm × 16.5 mm
- 93.4% efficiency end-to-end at full load
- <http://www.ti.com/tool/TIDA-01623>



Topology selection exercise

Design specification

- Class-D audio amplifier
- 90 V_{AC} to 265 V_{AC} input
- 200 W continuous, 750 W peak
- Small solution size preferable (length, width and height)



TIDA-00776

- Single phase CCM PFC + 2-switch forward
- Form factor: 88 mm x 173 mm x 35 mm
- <http://www.ti.com/tool/PMP30183>

Topology selection exercise

Design specification

- OLED TV
- 85 V_{AC} to 265 V_{AC} input
- Peak output power: 480 W
- AC/DC supply embedded within panel:
thin profile needed



TIDA-01495

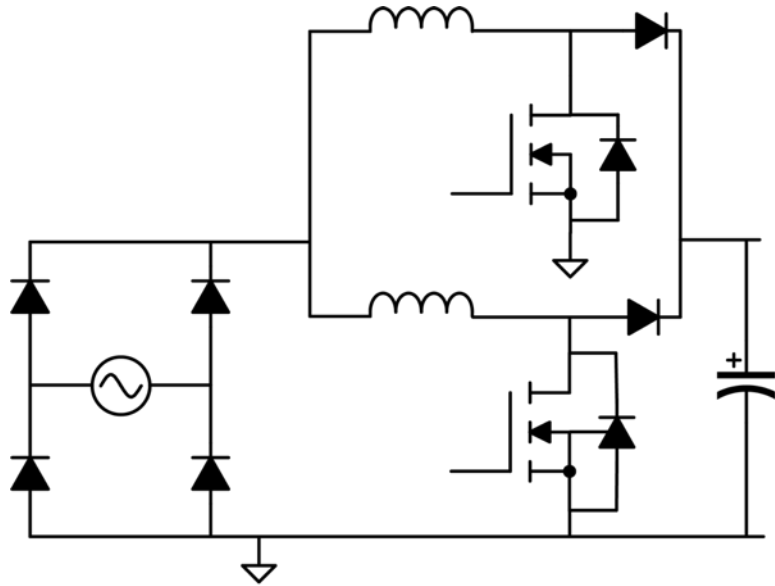
- Interleaved CrCM PFC + half-bridge LLC
- <17 mm height
- <http://www.ti.com/tool/TIDA-01495>

Summary

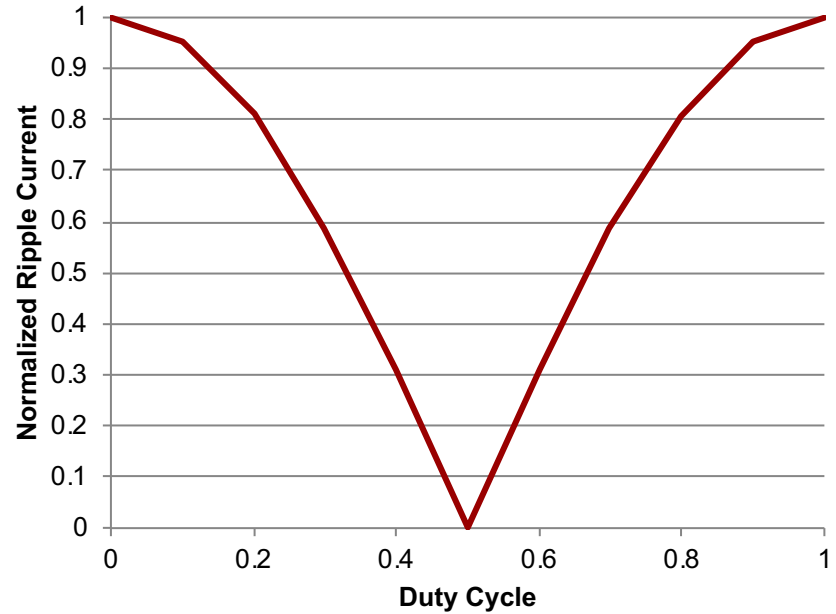
- **Overall**
 - Huge benefit to infrastructure
 - Regional regulatory requirements
- **Control method impacts power stage behavior**
 - Conduction losses
 - Switching losses
 - Switching frequency profile
- **PFC solution considerations**
 - Output power capability
 - Size
 - Complexity vs performance

BACKUP

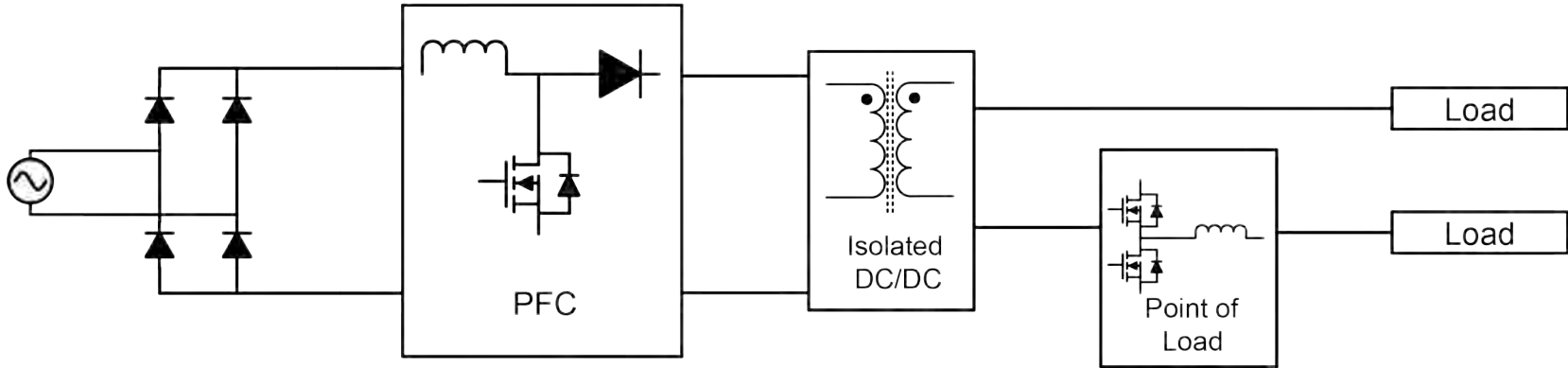
Interleaved PFC



Current Ripple Cancellation



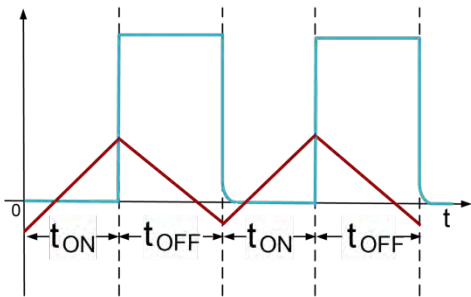
Benefits of active PFC



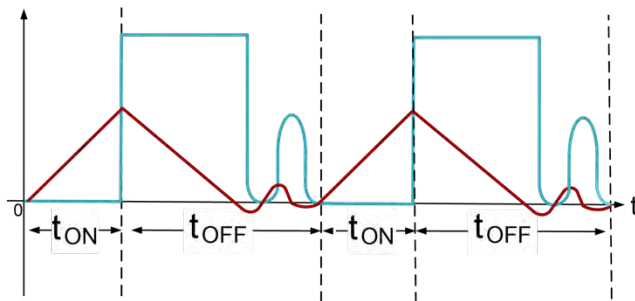
- **Output of PFC is a regulated voltage**
 - Easier design of isolated DC/DC stage
- **PFC can easily handle wide input voltage range**
 - One design able to support different line voltages around the world (115 V for US, 230 V for EU, 100 V for Japan, etc.)
- **PFC output capacitance provides holdup time when AC is disconnected**
 - Allows for a controlled shutdown sequence

Valley switching

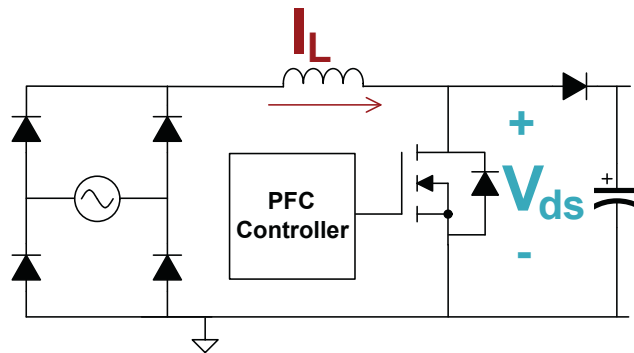
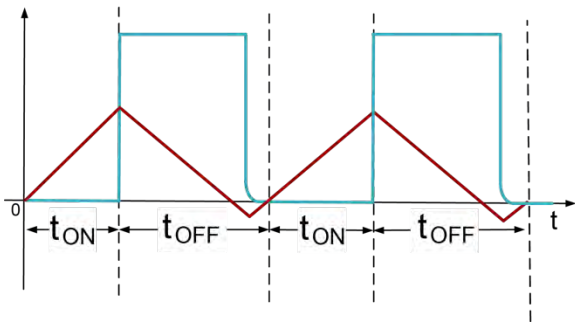
0th Valley



2nd Valley



1st Valley



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